



# N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
40	0.009 at V <sub>GS</sub> = 10 V	19	15 nC			
40	0.012 at V <sub>GS</sub> = 4.5 V	16				

# SO-8 S 1 8 D S 2 7 D S 3 6 D Top View

Ordering Information: Si4840BDY-T1-E3 (Lead (Pb)-free)

Si4840BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

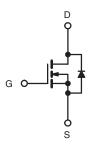
# **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS directive 2002/95/EC

# ROHS COMPLIANT HALOGEN FREE Available

# **APPLICATIONS**

- Synchronous Rectification
- POL, IBC
  - Secondary Side



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T <sub>A</sub> = 25 °C, unless otherwise noted					
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	$V_{DS}$	40	V		
Gate-Source Voltage	$V_{GS}$	± 20	v		
	T <sub>C</sub> = 25 °C		19		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I_	15		
Continuous Diam Current (1, = 150 C)	T <sub>A</sub> = 25 °C		12.4 <sup>a, b</sup>	A	
	T <sub>A</sub> = 70 °C		9.9 <sup>a, b</sup>	^	
Pulsed Drain Current		I <sub>DM</sub>	50		
Avalanche Current Avalanche Energy  L = 0.1 mH		I <sub>AS</sub>	15		
		E <sub>AS</sub>	11	mJ	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I.	5	А	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	2.1 <sup>a, b</sup>		
	T <sub>C</sub> = 25 °C		6		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	3.8	W	
Maximum Tower Dissipation	T <sub>A</sub> = 25 °C	] ' D	2.5 <sup>a, b</sup>	VV	
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>		
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	$R_{thJA}$	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	17	21	0/11		

## Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under Steady State conditions is 85 °C/W.
- d. Based on  $T_C = 25$  °C.

# Si4840BDY

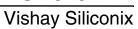
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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static	CySci	1991 991141119119		.,,,,	muxi	- Oille	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	40			V	
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>,J</sub>			40		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μA		- 6			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	1		3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
•		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V	1		1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			5		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.4 A		0.0074	0.009		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10.8 A		0.0095	0.012	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 12.4 A		56		S	
Dynamic <sup>b</sup>				I		l	
Input Capacitance	C <sub>iss</sub>			2000			
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		260		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			150			
Total Gate Charge		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.4 A		33	50	50	
	Q <sub>g</sub> V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12.47V		15	23	,,,		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 12.4 \text{ A}$		6.7		nC	
Gate-Drain Charge	$Q_{gd}$			5.1			
Gate Resistance	$R_g$	f = 1 MHz		1.4	2.1	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			25	40		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, R_L = 2 \Omega$		12	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		25	40		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		15	25		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		30	45		
Fall Time	t <sub>f</sub>			10	15		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			30	Δ	
Pulse Diode Forward Current	I <sub>SM</sub>				50	A	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			30	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 10 A dl/dt = 100 A/us T = 25 °C		26	52	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		17.5			
Reverse Recovery Rise Time t <sub>b</sub>				12.5		ns	

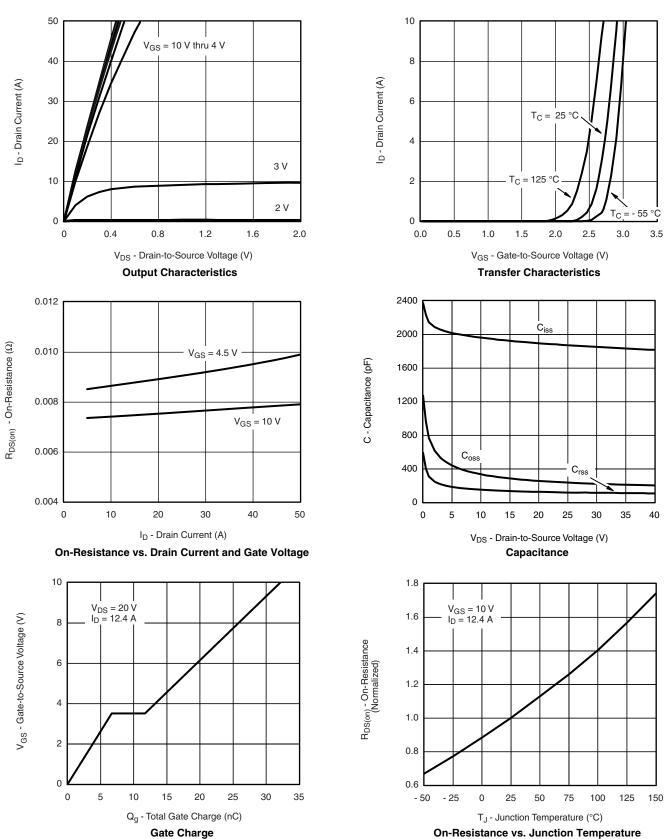
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



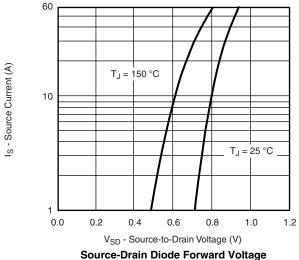


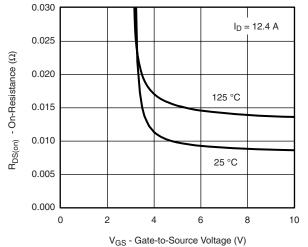
# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



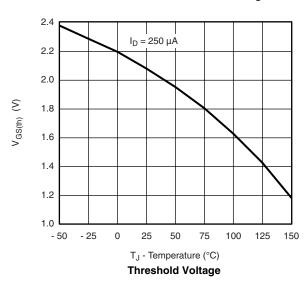
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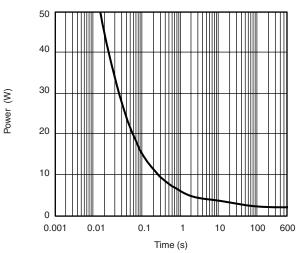
# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



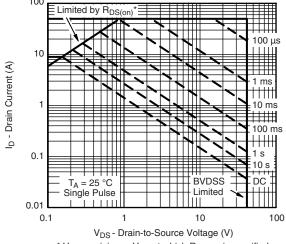








Single Pulse Power (Junction-to-Ambient)



\*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

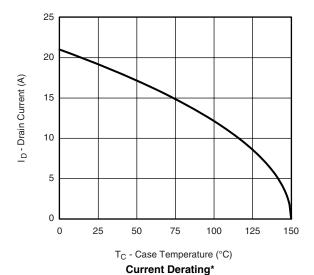
Safe Operating Area, Junction-to-Ambient

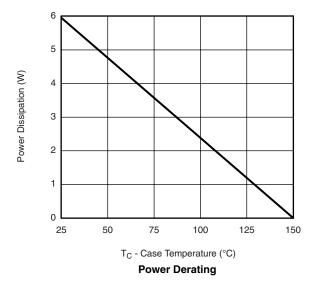




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# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



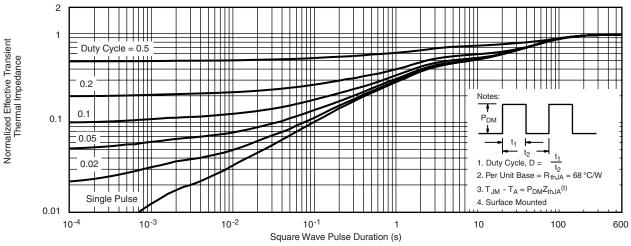


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

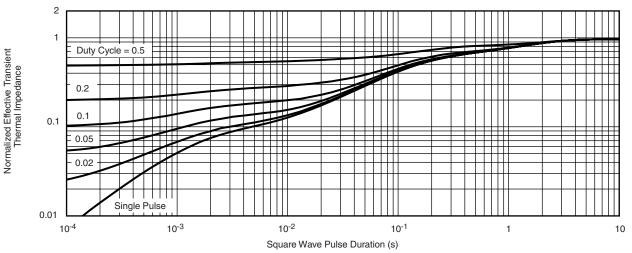
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# TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?69795">www.vishay.com/ppg?69795</a>.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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# **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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